

VENUE

“**Kambai-kan**” building in Muromachi Campus of Doshisha University

103 Gosho Yahata-cho, Kamidachiuri-sagaru, Karasuma-dori, Kamigyo-ku, Kyoto-shi, Kyoto, JAPAN

<http://www.doshisha.ac.jp/en/information/facility/kambai.html>

Kambai-kan is located in the center of Kyoto city and surrounded by a lot of temples, shrines, historical monuments etc.. It's easy to access from JR Kyoto station and Kansai international airport.



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PAPERS

For ISPS topic attendance, submitted manuscripts will be peer-reviewed and published in the International Journal of Microgravity Science and Application (IJMSA), an open access journal of JASMA.

For ITTW topic attendance, authors have the opportunity to submit papers by themselves for publication in Microgravity Science and Technology (MGST) or Interfacial Phenomena and Heat Transfer (IPHT).

(IJMSA) <http://www.jasma.info/journal/?lang=en>

(MGST) <http://www.springer.com/engineering/mechanical+engineering/journal/12217>

(IPHT) <http://www.begellhouse.com/journals/interfacial-phenomena-and-heat-transfer.html>

IMPORTANT DATES

Call for Abstract : 14 Nov., 2014 - 14 Feb., 2015

Notification of Acceptance : 30 Apr., 2015

Early Registration : 30 Apr., 2015 - 15 Jun., 2015

Call for Extended Abstract (ITTW Participants only) : 30 Apr., 2015 - 15 Jun., 2015

Call for Proceedings Manuscript (ISPS Participants only) : 1 Jul., 2015 - 18 Sep., 2015

WEB PAGE

http://www.jasma.info/ISPS-6_ITTW2015/ (to be opened on 22 Oct., 2014)

CONTACT

For programatic issues related to ISPS-6

ISPS-6 Secretary General : Dr. Satoshi MATSUMOTO (matsumoto.satoshi@jaxa.jp)

For programatic issues related to ITTW2015 including "extended abstract"

ITTW2015 Secretary General : Prof. Osamu KAWANAMI (kawanami@eng.u-hyogo.ac.jp)

For general issues related to the joint conference

JASMA Secretary : Mrs. Mana TAJIRI (isps-6_itw2015@jasma.info)



The Joint Conference of
6th International Symposium on Physical Sciences in Space
AND
10th International Conference on Two-Phase Systems
for Space and Ground Applications

